TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOS VII)

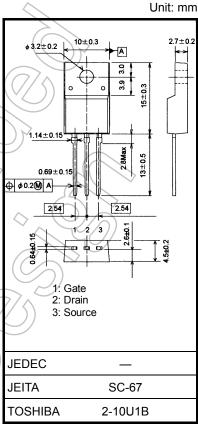
TK13A60D

Switching Regulator Applications

- Low drain-source ON-resistance: RDS (ON) = 0.33Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 6.5 \text{ S (typ.)}$
- Low leakage current: $I_{DSS} = 10 \mu A (max) (V_{DS} = 600 V)$
- Enhancement mode: $V_{th} = 2.0 \text{ to } 4.0 \text{ V (VDS} = 10 \text{ V, ID} = 1 \text{ mA)}$

Absolute Maximum Ratings (Ta = 25°C) Characteristics Symbol Rating Drain-source voltage V_{DSS} 600

Characteristics		Symbol	Rating	(Unit \	
Drain-source voltage		V_{DSS}	600	V	
Gate-source voltage			V _{GSS}	±30	À
Drain current	DC	(Note 1)	ID	13	A
	Pulse	(Note 1)	I _{DP}	52	^
Drain power dissipation (Tc = 25°C)			P _D	50	W
Single pulse avalanche energy (Note 2)		E _{AS}	511	mJ	
Avalanche current		IAR	13	A	
Repetitive avalanche energy (Note 3)		EAR	5.0	mJ	
Channel temperature			(T _{ch}	150	\/°C
Storage temperature range			T _{stg}	-55 to 150	°C



Weight: 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

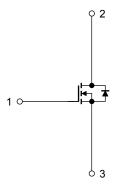
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	Rth (ch-c)	2.5	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 5.3 mH, $R_G = 25 \Omega$, $I_{AR} = 13 \text{ A}$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.



Start of commercial production 2008-07

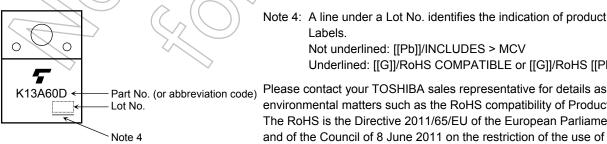
Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±1	μΑ
Drain cut-off curre	ent	I _{DSS}	V _{DS} = 600 V, V _{GS} = 0 V	_	_	10	μΑ
Drain-source brea	akdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	600 — —		_	V
Gate threshold vo	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	V
Drain-source ON	-resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 6.5 A	1	0.33	0.43	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 6.5 A	1.8	6.5	_	S
Input capacitance	•	C _{iss}		()	2300	_	
Reverse transfer capacitance		C _{rss}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	10	_	pF
Output capacitance		Coss		7 —	250	_	
Switching time	Rise time	t _r	10 V ID = 6.5 A VOUT	_	50	<u> </u>	
	Turn-on time	t _{on}	$\begin{array}{c c} 0 \text{ V} & & \\ \hline 50 \Omega & & \\ \end{array} \begin{array}{c} RL = 30 \Omega \end{array}$	-6	100	> —	ns
	Fall time	t _f	/// /////////////////////////////////		25) —	115
	Turn-off time	t _{off}	Duty ≤ 1%, t _w = 10 μs	(2)	140	_	
Total gate charge		Qg			40	_	
Gate-source charge		Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 13 \text{ A}$) —	25	_	nC
Gate-drain charge		Q _{gd}		_	15	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	IDR		_	_	13	Α
Pulse drain reverse current (Note 1)	I _{DRP}	(7/\\ -	_	_	52	Α
Forward voltage (diode)	V _{DSF}	$I_{DR} = 13 \text{ A, } V_{GS} = 0 \text{ V}$	_	_	-1.7	V
Reverse recovery time	trr	I _{DR} = 13 A, V _{GS} = 0 V,	_	1600	_	ns
Reverse recovery charge	Qrr	dI _{DR} /dt = 100 A/μs	_	20	_	μС

Marking



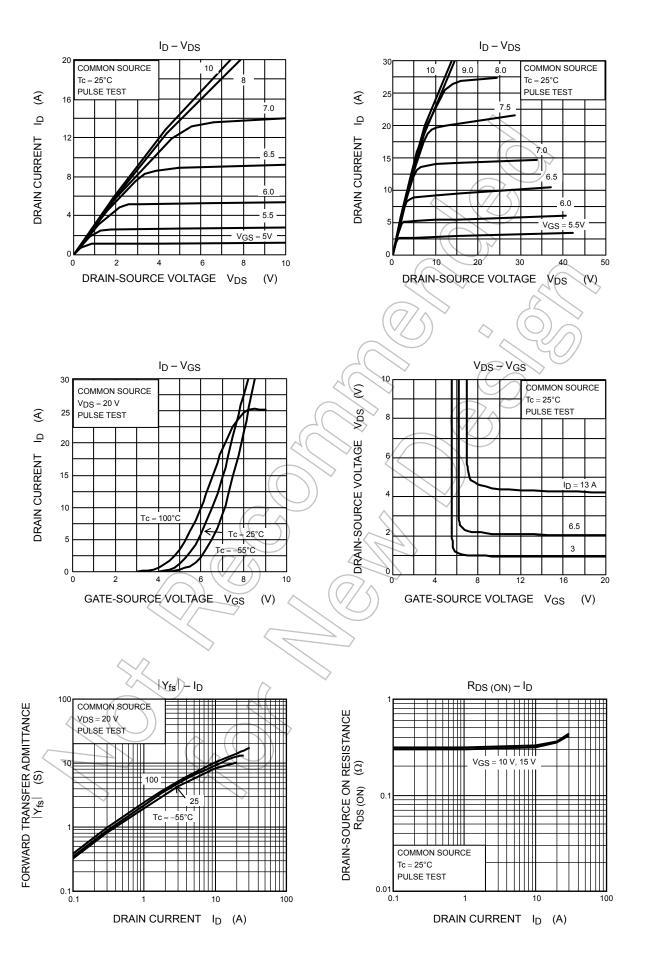
Note 4: A line under a Lot No. identifies the indication of product Labels.

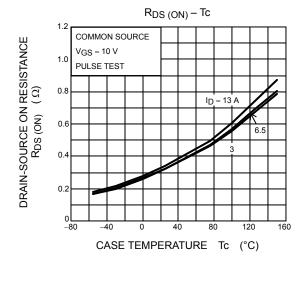
> Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

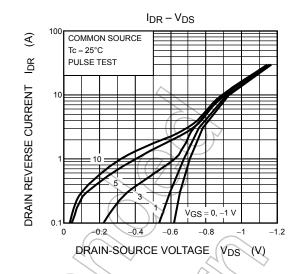
certain hazardous substances in electrical and electronic equipment.

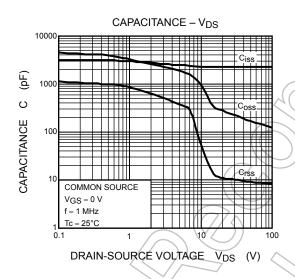
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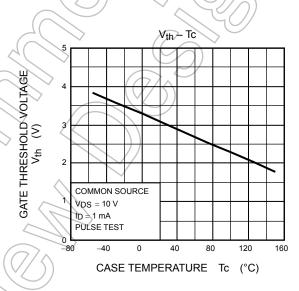
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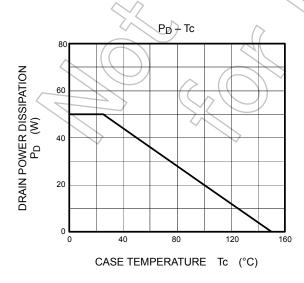


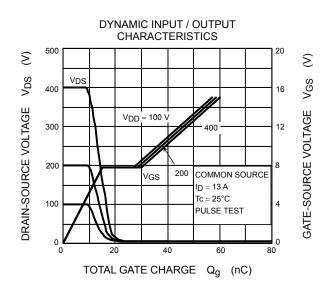


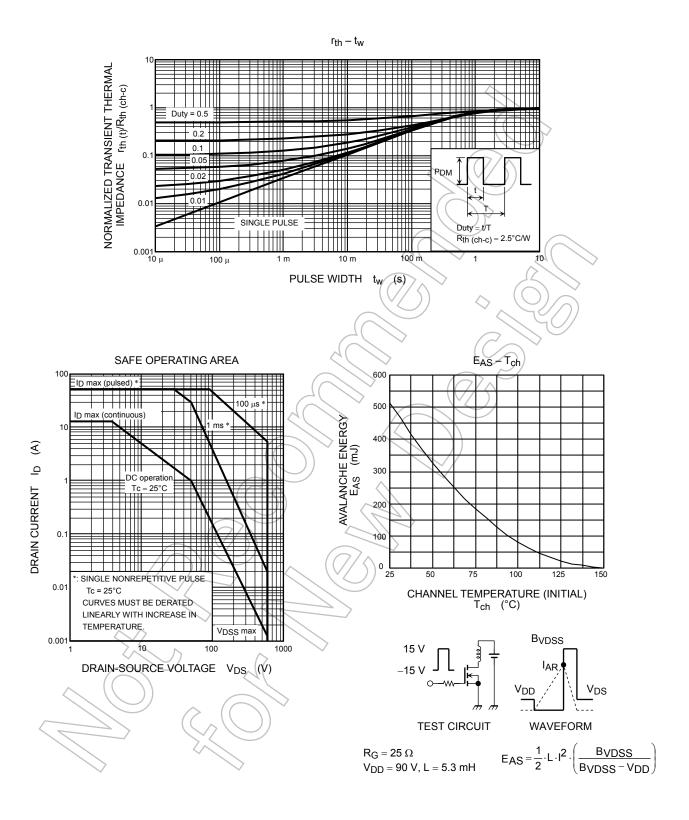












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